



Welcome to Rehm Mexico's 10th Anniversary and Technology Days!

Join us as we celebrate a decade of success at Rehm Mexico with two days of innovation and collaboration. Our experts from Rehm Thermal Systems will present the latest in soldering and coating technologies, supported by real customer use cases. The event will include sessions on convection reflow soldering, protective conformal coating, and vapor phase soldering for high-mass boards. In the afternoon, take part in technical workshops on our cutting-edge systems.

On the second day, join us for a panel discussion on future trends in electronics manufacturing, followed by a live machine demonstration and a tour of our Technology Center.



We look forward to celebrating and innovating with you!

AGENDA

Wednesday | July 2, 2025 Thursday | July 3, 2025

09.00 a.m Reg	egistration	09.00 a.m	Registration
09.30 a.m We	elcome 10 Years Rehm Mexico	09.30 a.m	Welcome
Joh	hannes Rehm, CEO Rehm Group		Luis A. García, General Manager Rehm México
10.00 a.m Inn	novative system technology for convection	09.45 a.m	Process Know-How for reflow soldering
ref	flow soldering - customer use case A		applications
Dr.	. Paul Wild, Rehm Thermal Systems		Dr. Paul Wild, Rehm Thermal Systems
10.30 a.m Pro	otective Conformal Coating for PCB's	10.30 a.m	Efficient Solutions for precise coating and
- Cl	ustomer use case A		despensing results
Gia	anfranco Sinistra, Rehm Thermal Systems		Gianfranco Sinistra, Rehm Thermal Systems
11.00 a.m Co f	offee Break	11:15 a.m	Coffee Break
11.30 a.m Va	por Phase Soldering for high-mass boards	11.45 a.m	Solder Graping Issue Analysis
- C	customer use case B		Dr. Jose Ma. Servin Olivares, Vitesco Cuautla
Dr.	. Paul Wild, Rehm Thermal Systems	12:15 a.m	Causes of Solder Separation and Possible Solutions
12.00 a.m Co	onformal Coating and Dispensing Solutions		Master of Science Omar Garcia Lopez, Flex North
for	r special applications	01:00 p.m	Lunch
- Cl	ustomer use case B	02.00 p.m	Panel Discussion: Future trends in electronics
Gia	anfranco Sinistra, Rehm Thermal Systems		manufacturing processes
12.30 p.m Me	exico at the Epicenter - Nearshoring, Resilience,		Johannes Rehm, Luis A. García, Gianfranco Sinistra,
and	d the Future of Talent in the Electronics Industry		Dr. Paul Wild, Ricardo Gallardo - Sanmina,
Lor	rena Villanueva,		Lorena Villanueva - IPC Mexico and other experts
Dire	rector Mexico Global Electronics Association	03.00 p.m	Open Machine Demonstration
01.00 p.m. Lur	nch		Technology Center Tour
02.00 p.m. Te d	echnical workshops	04.00 p.m	End of event
to • Vi	/isionXP+ 944 VAC system		

Contents subject to change without notice.

Information and Registration

Celebration Dinner

• ProtectoXC - Live Case Discussion together with the specialist Lackwerke Peters and Franco Sinistra

04.30 p.m · CondensoXC

06.30 p.m

Rehm Thermal Systems SA de CV
Parque Industrial TREX La Venta
Carretera a Nextipac No. 6645,
Colonia La Venta del Astillero, int. Nave 10,
Municipio de Zapopan, Jal., CP. 45221

La Macarena — Salón Boutique Av. Vallarta 6112, Ciudad Granja, Zapopan, Jal. 45017 México

Evening location

Registration Link



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